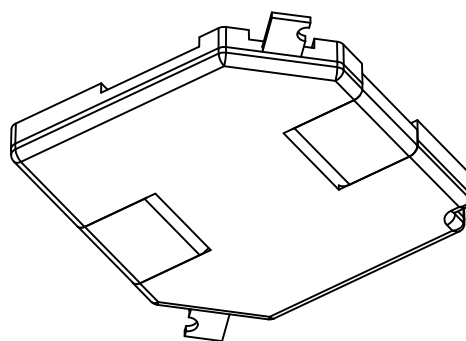
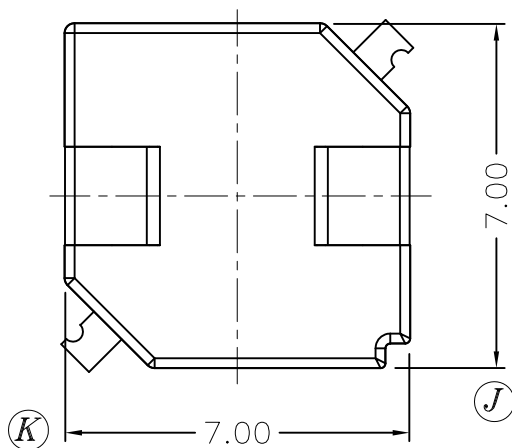
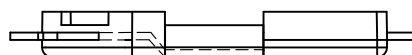
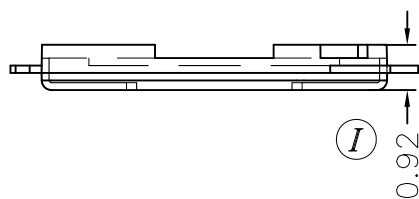
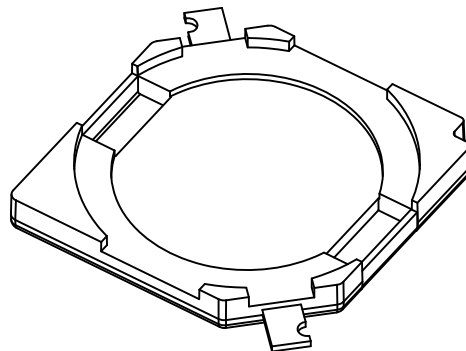
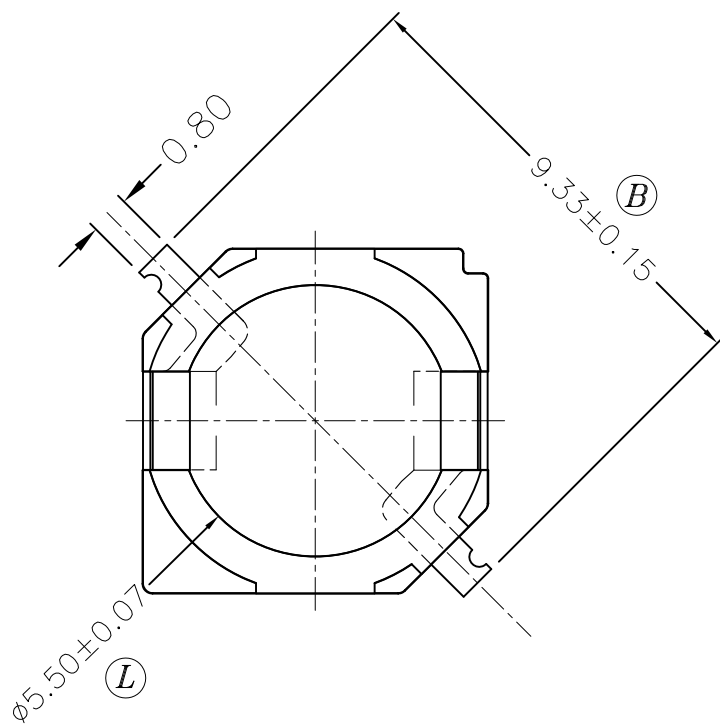




REV.	REVISIONS REC.	DATE	REV.	REVISIONS REC.	DATE
0	初版发行	MAR 14'05			MAY.05 '14
1	整理发行	MAY.28 '09			
2	胶体结构改变，M尺寸与H尺寸重复，去除M尺寸	MAY.05 '14			

DRAWN & DRAFTED BY	XING JY	TOLERANCES		ANGLE: ±1°	TITLE: SMD BASE 7.0x7.0		
CHECKED & APPROVED BY	BEN LEE	0<L≤4 ±0.1	COPLANARITY 0.1mm MAX	UNIT: MM	PLASTIC MATERIAL: LCP	UL REC. UL 94V-0	
		4<L≤16 ±0.2			METAL MATERIAL: PHOSPHON BRONZE	PIN TENSION LOAD: 1.0Kg	
		16<L≤63 ±0.3					
 广州市申拓电子有限公司 SMD-TOP ELECTRONIC (GZ) CO.,LTD. TEL:020-84842698 FAX:020-84842398				ORIGIN: GZ	DATE: MAY 05'2014	DRAWING NO. ST-BS007.01	REV. 2
							